

Taiwan Semiconductor

1A, 100V - 1000V Surface Mount Rectifiers

FEATURES

- Glass passivated devices
- Ideal for surface mounted applications
- Low leakage current
- Metallurgical bonded construction
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21
- Packing code with suffix "G" means

green compound (halogen-free)

MECHANICAL DATA

- Case: JEDEC SOD-123FL, molded plastic over passivated chip
- Terminals: Solder Plated, solderable per MIL-STD-750, Method 2026
- Weight: 21 ± 0.5mg





SOD-123FL



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS (T _A =25°C unless otherwise noted)								
PARAMETER	SYMBOL			TSOD1F		TSOD1F		UNIT
		1HM	2HM	4HM	6HM	8HM	10HM	
Device marking code		FB	FD	FG	FJ	FK	FM	
Maximum recurrent peak reverse voltage	V _{RRM}	100	200	400	600	800	1000	V
Maximum RMS voltage	V _{RMS}	70	140	280	420	560	700	V
Maximum DC blocking voltage	VDC	100	200	400	600	800	1000	V
Maximum average forward rectified current (Note 1)	I _(AV)				1	-		А
Peak forward surge current 8.3ms single half sine wave superimposed on rated load	IFSM	25			А			
Maximum instantaneous forward voltage at 1A (Note 2)	V _F	1.3		V				
Maximum DC reverse current $T_A=25^{\circ}C$	I				5			
at rated DC blocking voltage	- I _R	50					μA	
Maximum reverse recovery time (Note 3)	t _{rr}	1	150		250	5	00	ns
Typical junction capacitance (Note 4)	CJ	4		pF				
Typical thermal resistance (Note 5)	R _{θJA}	180 K/			K/W			
Junction and Storage Temperature Range	T_J,T_STG	-55 to +150 °			°C			
Note 1: Averaged over any 20ms period	•	•						

Note 1: Averaged over any 20ms period.

Note 2: Pulse test: 300µs pulse width, 1% duty cycle.

Note 3: Measured with I_F =0.5A, I_R =1A, I_{rr} =0.25A

Note 4: Measured at 1.0MHz and applied average voltage of 4.0V DC.

Note 5: Thermal resistance junction to ambient, 6.0 mm² copper pads to each terminal.

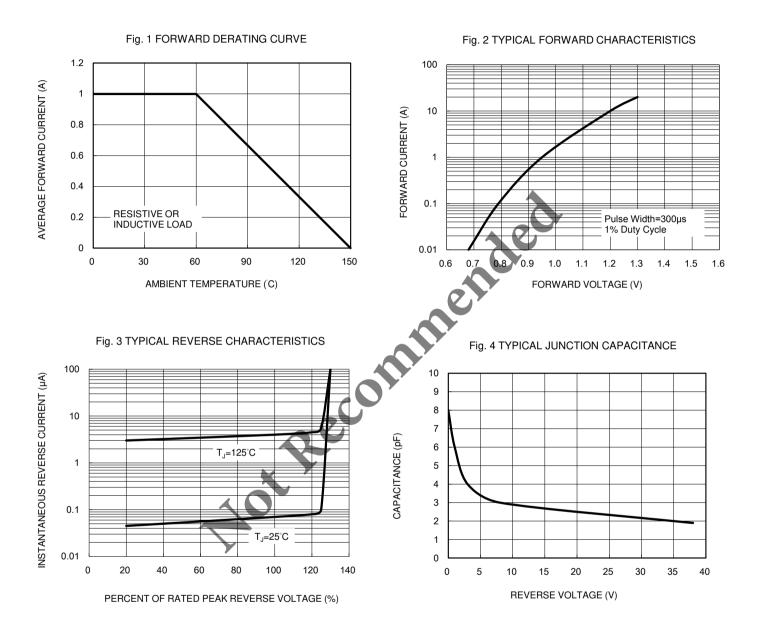


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RATINGS AND CHARACTERISTICS CURVES

(T_A=25°C unless otherwise noted)





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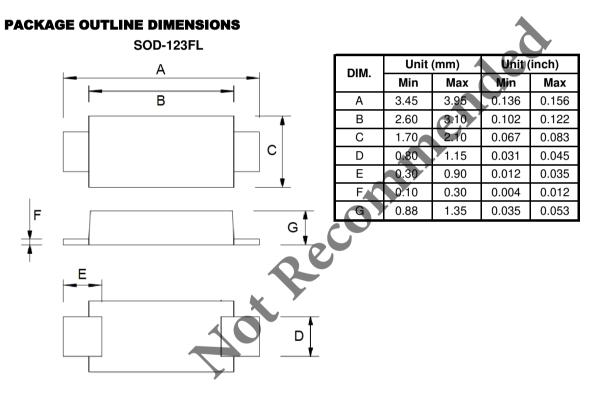
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ORDERING INFORMATION						
	PART NO. PACKING CODE		PACKING CODE SUFFIX	PACKAGE	PACKING	
	TSOD1FxHM (Note 1, 2)	R4	G	SOD-123FL	10,000 / 13" reel	

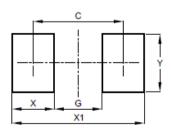
Note 1: "x" defines voltage from 100V (TSOD1F1HM) to 1000V (TSOD1F10HM)

Note 2: Whole series with green compound

EXAMPLE						
PREFERRED P/N	PART NO.	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION		
TSOD1F1HM R4G	TSOD1F1HM	R4	G	Green compound		



SUGGEST PAD LAYOUT



DIM.	Unit (mm)	Unit (inch)		
DIM.	Тур.	Тур.		
С	4.00	0.157		
G	3.00	0.118		
Х	1.20	0.047		
X1	4.90	0.193		
Y	1.20	0.047		



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TSOD1F1HM - TSOD1F10HM Taiwan Semiconductor



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